

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Akihiko ENDO et al. Group Art Unit : 2891
Appl. No. : 10/570,669 Examiner : Asok K SARKAR
Filed : March 6, 2006 Confirmation No. : 1242
For : SOI WAFER AND ITS MANUFACTURING METHOD

SECOND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop **AMENDMENT**
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir :

In accordance with the duty of disclosure under 37 C.F.R. § 1.56 and §§ 1.97-1.98, and supplemental to the Information Disclosure Statements that were previously filed on March 6, 2009 and June 14, 2006, Applicants submit herewith a Japanese Office Action dated November 6, 2009, that issued with respect to patent family member Japanese Patent Application No. 2005-513881, in which the following documents were cited:

- 1) JP 8-139295;
- 2) JP 11-307470;
- 3) JP 05-226620; and
- 4) JP 08-037286.

The relevance of these documents, as ascertained with respect to the Japanese claims by the Japanese Examiner, is set forth in the Japanese Office Action.

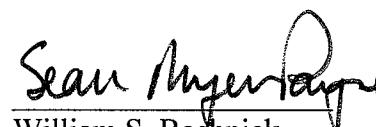
Applicants note that above-noted documents (1)-(4) were previously cited in the Information Disclosure Statement filed on June 14, 2006, and thus, copies of these documents

are not enclosed herewith. A copy of the Japanese Office Action is attached hereto so that the record is complete.

Applicants submit that no fee or certification is required to ensure consideration of these materials, as they were already considered.

If there should be any questions, the Examiner is invited to contact the undersigned at the telephone number listed below.

Respectfully Submitted,
Akihiko ENDO et al.


William S. Boshnick
Reg. No. 44,550 *42,920*

November 23, 2009
GREENBLUM & BERNSTEIN, P.L.C.
1950 Roland Clarke Place
Reston, VA 20191
(703) 716-1191